PATENT NUMBER.

# U.S. **UTILITY** Patent Application

| O.I.P.E. | PATENT DATE |
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| SCANNED    Q.A. | |

| APPLICATION NO. | CONT/PRIOR | CLASS | SUBCLASS | ART UNIT | EXAMINER     THAI |
|---|---|---|---|---|---|
| 09/761886 | | -327 | | -2816 | |
| | | | | 2827 | |

**APPLICANTS**

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**TITLE**

Bonding pad for flip-chip fabrication

PTO-2040
12/99

## ISSUING CLASSIFICATION

| ORIGINAL | | | CROSS REFERENCE(S) | | | | | |
|---|---|---|---|---|---|---|---|---|
| CLASS | SUBCLASS | CLASS | SUBCLASS (ONE SUBCLASS PER BLOCK) | | | | | |
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| INTERNATIONAL CLASSIFICATION | | | | | | | | |
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| | | | | | ☐ Continued on Issue Slip Inside File Jacket | | | |

| TERMINAL ☐ DISCLAIMER | DRAWINGS | | | CLAIMS ALLOWED | |
|---|---|---|---|---|---|
| | Sheets Drwg. | Figs. Drwg. | Print Fig. | Total Claims | Print Claim for O.G. |

| ☐ The term of this patent subsequent to _____ (date) has been disclaimed. | | NOTICE OF ALLOWANCE MAILED |
|---|---|---|
| | (Assistant Examiner)          (Date) | |
| ☐ The term of this patent shall not extend beyond the expiration date of U.S Patent. No. _____ _____ _____ | | ISSUE FEE |
| | | Amount Due          Date Paid |
| | (Primary Examiner)          (Date) | ISSUE BATCH NUMBER |
| ☐ The terminal ____months of this patent have been disclaimed. | (Legal Instruments Examiner)          (Date) | |

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